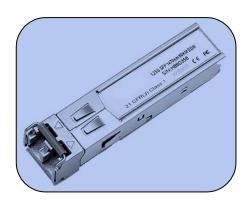


# **XSM851-M5Lx**

# 1.25Gbps SFP Optical Transceiver, 550m Reach



#### **Applications**

- o Gigabit Ethernet
- o Fiber Channel
- o Switch to Switch interface
- o Switched backplane applications
- o Router/Server interface
- o Other optical transmission systems

## **Product Highlights**

- Data-rate of 1.25Gbps operation
- 850nm VCSEL laser and PIN photodetector
- Compliant with SFP MSA and SFF-8472 with duplex LC receptacle
- Digital Diagnostic Monitoring: Internal Calibration or External Calibration
- 500m transmission with 50/125µm MMF
- 300m transmission with 62.5/125µm MMF
- Compatible with RoHS
- +3.3V single power supply
- Operating case temperature:

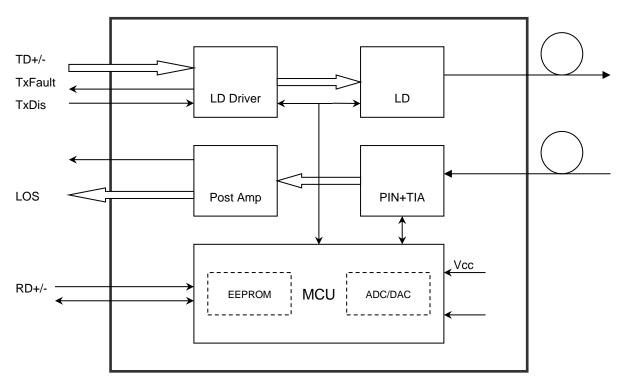
Standard: 0 to +70°C Extended: -20 to +85°C Industrial: -40 to +85°C

#### Description

The SFP transceivers are high performance, cost effective modules supporting data-rate of 1.25Gbps and 550m transmission distance with MMF.

The transceiver consists of three sections: a VCSEL laser transmitter, a PIN photodiode integrated with a trans-impedance preamplifier (TIA) and MCU control unit. All modules satisfy class I laser safety requirements.

The transceivers are compatible with SFP Multi-Source Agreement (MSA) and SFF-8472. For further information, please refer to SFP MSA.





# **Absolute Maximum Ratings**

Parameters	Symbol	Min.	Max.	Unit
Power Supply Voltage	V <sub>CC</sub>	-0.5	4.5	V
Storage Temperature	Tst	-40	85	°C
Operating Humidity		5	85	%

Table 1 - Absolute Maximum Ratings

## **Recommended Operating Environment**

Parameters	Symbol	Min.	Typical	Max.	Unit
Power Supply Voltage	Vcc	3.13	3.3	3.47	V
Power Supply Current	Icc			300	mA
Operating Case temperature - Std	Тс	0		70	ōС
Operating Case temperature - Ext	Тс	-20		85	ōС
Operating Case temperature - Ind	Тс	-40		85	ōС
Data Rate			1.25		Gbps

**Table 2 - Recommended Operating Conditions** 

## **Optical and Electrical Characteristics**

XSM851-M5Lx: (VCSEL and PIN, 500m Reach)

Parameters		Symbol	Min.	Typical	Max.	Unit	Notes
			Transmitt	ter			
Center Wavele	ngth	λο	830	850	860	nm	
Spectral Width (	RMS)	Δλ			0.85	nm	
Average Output I	Power	Pout	-9.5		-3.5	dBm	1
Extinction Ratio		ER	9			dB	
Optical Rise/Fall Time (20%~80%)		tr/tf			0.26	ns	
Data Input Swing Di	Data Input Swing Differential		400		1800	mV	2
Input Differential Im	Input Differential Impedance		90	100	110	Ω	
TV Disable	Enable	2.0		Vcc	V	V	
TX Disable	Disable	0		0.8	V	V	
TV Facility	Fault	2.0		Vcc	V	V	
TX Fault	Normal	0		0.8	V	V	



Parameters		Symbol	Min.	Typical	Max.	Unit	Notes
			Receive	r			
Centre Waveler	ngth	λc	770		860	nm	
Receiver Sensit	ivity				-18	dBm	3
Receiver Overl	oad		0			dBm	3
LOS De-Assert		LOS <sub>D</sub>			-18	dBm	
LOS Assert		LOS <sub>A</sub>	-30			dBm	
LOS Hysteresis			1		4	dB	
Data Output Swing Differential		Vout	370		1800	mV	4
LOS	Enable	High	2.0		Vcc	V	
LUS	Disable	Low			0.8	V	

### Notes:

- 1. The optical power is launched into SMF.
- 2. PECL input, internally AC-coupled and terminated.
- 3. Measured with a PRBS  $2^7$ -1 test pattern @1250Mbps, BER  $\leq 1 \times 10^{-12}$ .
- 4. Internally AC-coupled.

**Table 3 - Optical and Electrical Characteristics** 

## **Timing and Electrical**

Parameters	Symbol	Min.	Typical	Max.	Unit
Tx Disable Negate Time	t_on			1	ms
Tx Disable Assert Time	t_off			10	μs
Time To Initialize, including Reset of Tx Fault	t_init			300	ms
Tx Fault Assert Time	t_fault			100	μs
Tx Disable To Reset	t_reset	10			μs
LOS Assert Time	t_loss_on			100	μs
LOS De-assert Time	t_loss_off			100	μs
Serial ID Clock Rate	f_serial_clock			400	KHz
MOD_DEF (0:2)-High	VH	2		Vcc	V
MOD_DEF (0:2)-Low	VL			0.8	V

**Table 4 - Timing and Electrical** 



### Diagnostics

Parameters	Range	Unit	Accuracy	Calibration
Temperature	0 to +70	°C	±3°C	Internal / External
	-40 to +85	0 to +85		
Voltage	3.0 to 3.6	V	±3%	Internal / External
Bias Current	0 to 100	mA	±10%	Internal / External
TX Power	-9.5 to -3.5	dBm	±3dB	Internal / External
RX Power	-18 to -3	dBm	±3dB	Internal / External

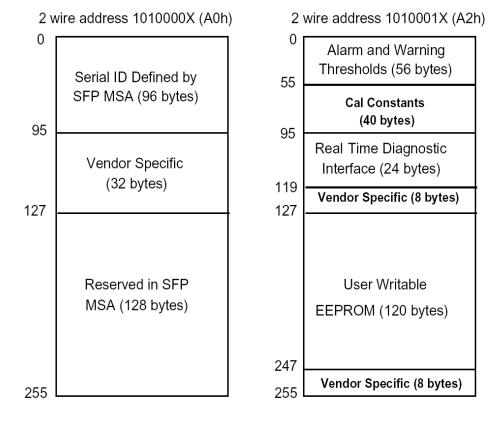
Table 5 – Diagnostics Specification

### **Digital Diagnostic Memory Map**

The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

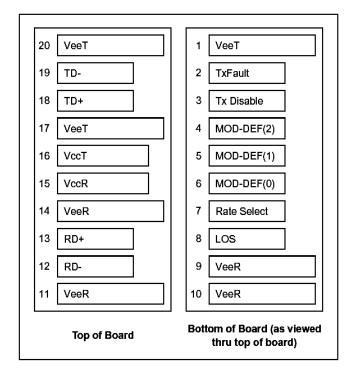
The diagnostic information with internal calibration or external calibration all are implemented, including received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring.

The digital diagnostic memory map specific data field defines as following.





# **Pin Definition Diagram**



## **PIN** description

Pin	Symbol	Name/Description	Plug Seq.	Note
1	VEET	Transmitter Ground	1	
2	TX_Fault	Transmitter Fault Indication	3	Note 1
3	TX_Disable	Transmitter Disable	3	Note 2
4	MOD_DEF(2)	SDA Serial Data Signal	3	Note 3
5	MOD_DEF(1)	SCL Serial Clock Signal	3	Note 3
6	MOD_DEF(0)	TTL Low	3	Note 3
7	Rate Select	Not Connected	3	
8	LOS	Loss of Signal	3	Note 4
9	VEER	Receiver ground	1	
10	VEER	Receiver ground	1	
11	VEER	Receiver ground	1	
12	RD-	Inv. Received Data Out	3	Note 5
13	RD+	Received Data Out	3	Note 5
14	VEER	Receiver ground	1	
15	VCCR	Receiver Power Supply	2	
16	VCCT	Transmitter Power Supply	2	
17	VEET	Transmitter Ground	1	
18	TD+	Transmit Data In	3	Note 6
19	TD-	Inv. Transmit Data In	3	Note 6
20	VEET	Transmitter Ground	1	



#### Notes:

Plug Seq.: Pin engagement sequence during hot plugging.

1) TX Fault is an open collector output, which should be pulled up with a  $4.7k^{-1}0k\Omega$  resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; Logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.

2) TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a  $4.7k^{\sim}10k\Omega$  resistor. Its states are:

Low (0 to 0.8V): Transmitter on (>0.8V, < 2.0V): Undefined

High (2.0 to 3.465V): Transmitter Disabled Open: Transmitter Disabled

3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a  $4.7k^{\sim}10k\Omega$  resistor on the host board. The pull-up voltage shall be VccT or VccR.

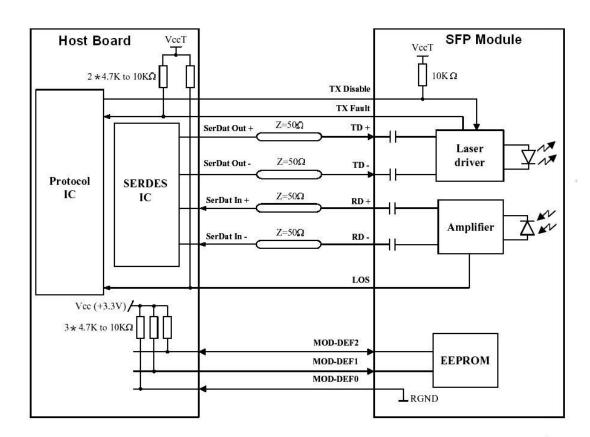
Mod-Def 0 is grounded by the module to indicate that the module is present

Mod-Def 1 is the clock line of two wire serial interface for serial ID

Mod-Def 2 is the data line of two wire serial interface for serial ID

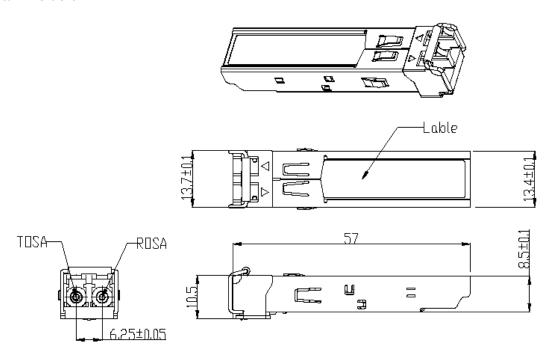
- 4) LOS is an open collector output, which should be pulled up with a  $4.7k^{\sim}10k\Omega$  resistor. Pull up voltage between 2.0V and Vcc+0.3V. Logic 1 indicates loss of signal; Logic 0 indicates normal operation. In the low state, the output will be pulled to less than 0.8V.
- 5) RD-/+: These are the differential receiver outputs. They are internally AC-coupled 100 differential lines which should be terminated with  $100\Omega$  (differential) at the user SERDES.
- 6) TD-/+: These are the differential transmitter inputs. They are internally AC-coupled, differential lines with  $100\Omega$  differential termination inside the module.

#### **Recommended Interface Circuit**





#### **Mechanical Dimensions**



#### **Ordering information**

Part Number	Product Description
XSM851-M5LN	850nm, 1.25Gbps, 550m, 0°C ~ +70°C
XSM851-M5LY	850nm, 1.25Gbps, 550m, 0°C ~ +70°C, With Digital Diagnostic Monitoring
XSM851-M5LD	850nm, 1.25Gbps, 550m, -20ºC ~ +85ºC
XSM851-M5LE	850nm, 1.25Gbps, 550m, -20ºC ~ +85ºC, With Digital Diagnostic Monitoring
XSM851-M5LL	850nm, 1.25Gbps, 550m, -40ºC ~ +85ºC
XSM851-M5LM	850nm, 1.25Gbps, 550m, -40ºC ~ +85ºC, With Digital Diagnostic Monitoring

Notice. Please specify any compatibility requirements at time of ordering. Standard MSA compatible pluggable components may not work or some function of these components may not be available in devices that require customized compatible devices. Pluggable components compatible with one type of communications equipment may not work in other type of communications equipment.

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